

RF360 Europe GmbH

A Qualcomm – TDK Joint Venture

## **SAW Components**

## **BAW Bluetooth/WLAN Filter**

Datasheet

Series/type:B8850Ordering code:B39242B8850P810

Date: Version: October 07, 2015 2.2

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B8850

2442.0 MHz

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Datasheet

### Application

Ultra low-loss BAW RF single filter for Bluetooth/WLAN with LTE Band 7 / Band 40 / Band 41 coexistence

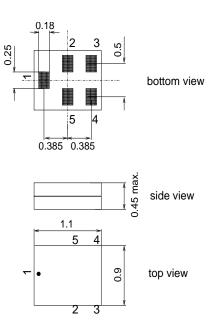
SMD

- Usable passband 79.0 MHz
- Unbalanced to unbalanced operation
- Excellent insertion attenuation
- High out of band selectivity
- Filter impedance 50 Ω
- Good B40 attenuation
- Very low 2nd harmonic generation
- Excellent VSWR flatness across passband



#### Features

- Package size 1.1 x 0.9 mm<sup>2</sup>
- Package height 0.45 mm max
- RoHS compatible
- Approximate weight 0.0012 g
- Package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL 3)



### **Pin configuration**

B8850 supports two I/O pinning configurations

- For 2G only stand alone applications, recommend Pin 4 to PA, Pin 1 to ANT orientation for best harmonics performance.
- 2) For 2G+5G applications (with diplexer),filter supports either Pin 4 to PA, Pin 1 to ANT(or) Pin 4 to ANT, Pin 1 to PA configuration.

Pins 2,3,5 : To be grounded

2



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### **BAW Bluetooth/WLAN Filter**

**Datasheet** 

#### **Characteristics of Filter**

Temperature range for specification:				
Terminating source impedance:				
Terminating load impedance:				

Т	=	−30 °C to +85 °C
$Z_S$	=	50 $\Omega$ shunt coil 8.2 nH
$Z_L$	=	50 $\Omega$ shunt coil 10 nH

SMD

Characterist	ioc				min.	tun	may	+
Characterist	ics				min.	typ. @ 25 °C	max.	
Center frequency f <sub>c</sub>				f <sub>C</sub>	—	2442.0		MHz
Maximum ins	sertion at	tenuation -	WLAN <sup>1)</sup>	$\alpha_{max}$				
2403.1 2420.9 MHz (channel 1)					—	1.35 <sup>1)</sup>	1.9 <sup>1)</sup>	dB
2408.1 2425.9 MHz (channel 2)					—	1.15 <sup>1)</sup>	1.8 <sup>1)</sup>	dB
2413.1 2470.9 MHz (channel 3-11)				—	1.001)	1.8 <sup>1)</sup>	dB	
2458.1 2475.9 MHz (channel 12)				—	1.05 <sup>1)</sup>	1.8 <sup>1)</sup>	dB	
2463.1 2480.9 MHz (channel 13)				—	1.25 <sup>1)</sup>	2.0 <sup>1)</sup>	dB	
VSWR (Pin 1	)							
	2403.1	2425.9	MHz		—	1.6	2.3 <sup>3)</sup>	
	2425.9	2480.9	MHz		—	1.6	2.4	
VSWR (Pin 4	L)							
	2403.1	2425.9	MHz		—	1.4	2.3 <sup>3)</sup>	
	2425.9	2480.9	MHz		—	1.4	2.4	
Attenuation				α				
	699.0	960.0	MHz		29	32		dB
	1710.0	2170.0	MHz		28	31		dB
	2300.0	2360.0	MHz		32	37		dB
	2360.0	2370.0	MHz		33 <sup>2)</sup>	402)		dB
	2370.0	2380.0	MHz		6 <sup>2)</sup>	34 <sup>2)</sup>		dB
	2500.0	2505.0	MHz		<b>30</b> <sup>2)3)</sup>	55 <sup>2)</sup>		dB
	2505.0	2570.0	MHz		36 <sup>2)</sup>	41 <sup>2)</sup>		dB
	2570.0	2620.0	MHz		34 <sup>2)</sup>	39 <sup>2)</sup>		dB
	2620.0	2690.0	MHz		34 <sup>2)</sup>	39 <sup>2)</sup>		dB
	4800.0	5805.0	MHz		20	28		dB

Averaged values within each WiFi channel width of 17.8 MHz
Averaged value of linear S-parameter over any 5 MHz

<sup>3)</sup> From 25°C to 85°C

3





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## **BAW Bluetooth/WLAN Filter**

Datasheet

SMD

### Maximum ratings

Operable temperature range	Т	-30/+85	°C	
Storage temperature range	T <sub>stg</sub>	-40/+90	°C	
DC voltage	V <sub>DC</sub>	5 <sup>1)</sup>	V	
ESD voltage	V <sub>ESD</sub>	50 <sup>2)</sup>	V	Machine Model
		300 <sup>3)</sup>	V	Human Body Model
		600 <sup>4)</sup>	V	Charged Device Model
Input power at PIN 1 or PIN 4		.00	dDm	20 MHz OFDM signal, 65°C,
channel 1 to channel 13		+26	dBm	5000hr

<sup>1)</sup> 168h Damp Heat Steady State acc. to IE C60068-2-67 Cy

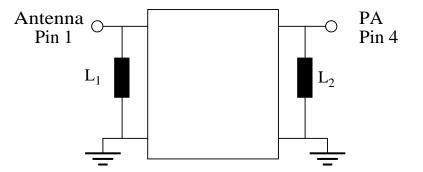
<sup>2)</sup> acc. to JESD22-A115B (MM - Machine Model), 10 negative and 10 positive pulses

<sup>3)</sup> acc. to JESD22-A114F (HBM - Human Body Model), 1 negative and 1 positive pulses

<sup>4)</sup> acc. to JESD22-C101C (CDM - Field Induced Charged Device Model), 3 negative and 3 positive pulses

### Matching network

- L<sub>1</sub> = 8.2 nH
- L<sub>2</sub> = 10 nH
- Recommendation to use TDK MLG0603 P-series



4

B8850

B8850

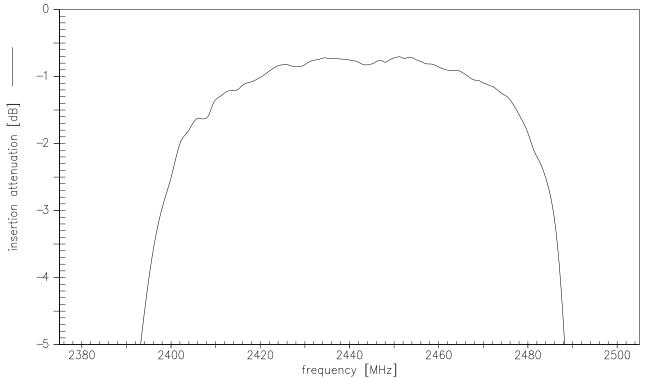
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2442.0 MHz

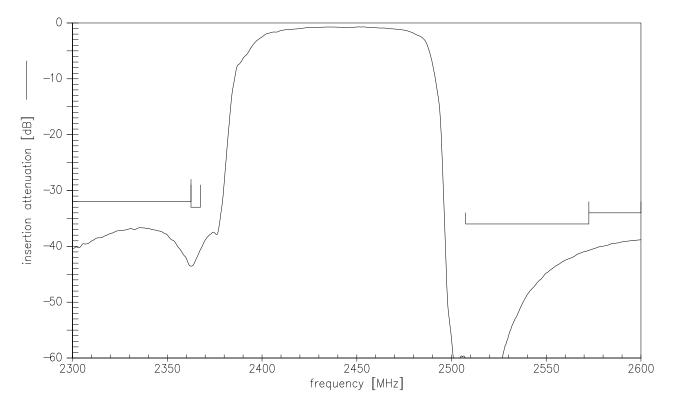
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## **Transfer function**



SMD

## **Transfer function**



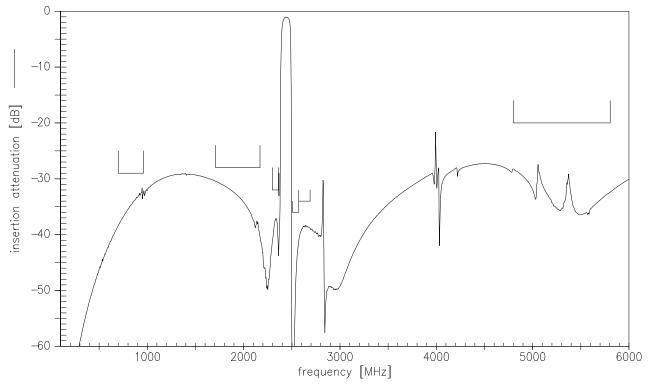
## **SAW Components**

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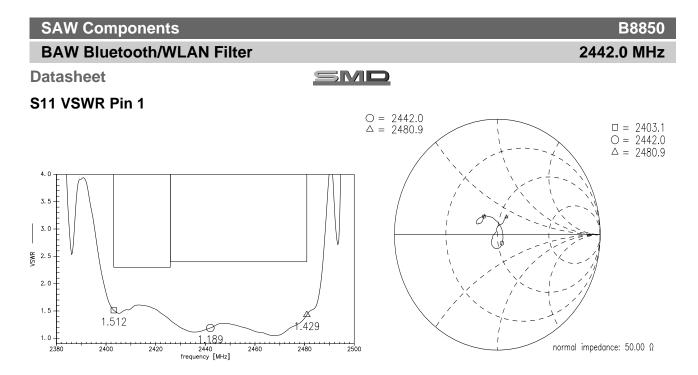
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## **Transfer function**

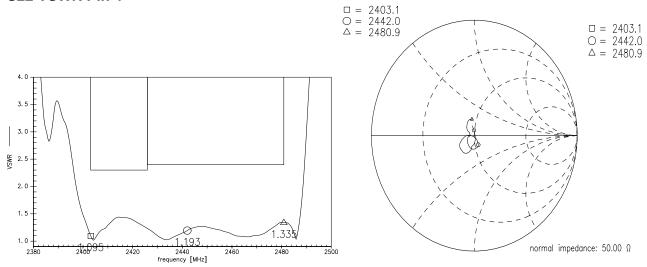


6

B8850



S22 VSWR Pin 4



7

## **SAW Components**

## **BAW Bluetooth/WLAN Filter**

Datasheet

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### References

Туре	B8850			
Ordering code	B39242B8850P810			
Marking and package	C61157-A8-A185			
Packaging	F61074-V8255-Z000			
Date codes	L_1126			
S-parameters	B8850_HDWB.s2p See file header for port/pin assignment table.			
Soldering profile	S_6001			
RoHS compatible	RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8 <sup>th</sup> , 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases.			
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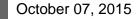
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8



B8850



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9